

SS32 - S310

Features

- · Metal to silicon rectifiers, majority carrier conduction.
- Low forward voltage drop.
- Easy pick and place.
- High surge current capability.



SMC/DO-214AB COLOR BAND DENOTES CATHODE

Schottky Rectifiers

Absolute Maximum Ratings* T_A = 25°C unless otherwise noted

Symbol	Parameter		Value							
			33	34	35	36	38	39	310]
V_{RRM}	Maximum Repetitive Reverse Voltage		30	40	50	60	80	90	100	V
I _{F(AV)}	Average Rectified Forward Current, @ T _A = 75°C 3.0				Α					
I _{FSM}	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave			Α						
T _{sta}	Storage Temperature Range -55 to +150			°C						
T _J	Operating Junction Temperature -55 to +150			°C						

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

Symbol	Parameter	Value	Units		
P_{D}	Power Dissipation	2.27	W		
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient *	55	°C/W		
$R_{\theta JL}$	Thermal Resistance, Junction to Lead	17	°C/W		

^{*}Device mounted on FR-4 PCB 0.55 x 0.55" (14 x 14 mm).

$\begin{tabular}{ll} \textbf{Electrical Characteristics} & \textbf{T}_{A} = 25^{\circ}\text{C unless otherwise noted} \\ \end{tabular}$

Symbol	nbol Parameter		Device								Units
				33	34	35	36	38	39	310	
V _F	Forward Voltage @ 3.0 A			500		750			850	1	mV
I _R	Reverse Current @ rated V_R $T_A = 25^{\circ}C$		0.5							mA	
		T _A = 100°C		20				10			mA

Schottky Rectifiers

(continued)

Typical Characteristics

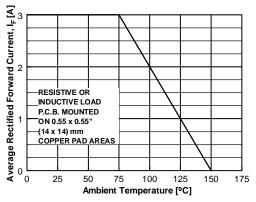


Figure 1. Forward Current Derating Curve

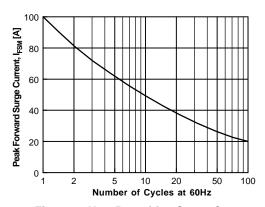


Figure 2. Non-Repetitive Surge Current

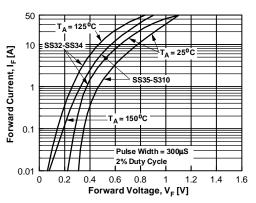


Figure 3. Forward Voltage Characteristics

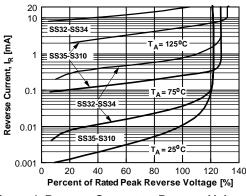


Figure 4. Reverse Current vs Reverse Voltage

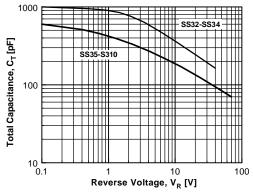


Figure 5. Total Capacitance

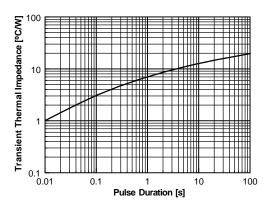


Figure 6. Thermal Impedance Characteristics

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